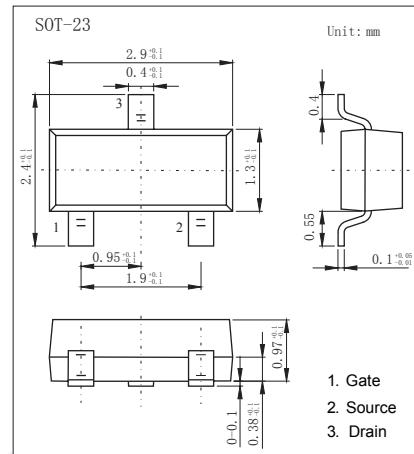
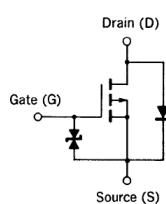


## P-Channel MOSFET

## 2SJ211

## ■ Features

- $V_{DS(V)} = -100V$
- $I_D = -0.2 A$
- $R_{DS(ON)} < 20 \Omega (V_{GS} = -10V)$
- $R_{DS(ON)} < 30 \Omega (V_{GS} = -4V)$

■ Absolute Maximum Ratings  $T_a = 25^\circ C$ 

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current	$I_D$	-0.2	A
Pulsed Drain Current (Note.1)	$I_{DM}$	-0.4	
Power Dissipation	$P_D$	0.2	W
Junction Temperature	$T_J$	150	
Junction Storage Temperature Range	$T_{stg}$	-55 to 150	$^\circ C$

Note.1:  $PW \leq 10 \text{ ms}$ , duty cycle  $\leq 50\%$

■ Electrical Characteristics  $T_a = 25^\circ C$ 

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{DSS}$	$I_D = -250 \mu A, V_{GS} = 0V$	-100			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -100V, V_{GS} = 0V$			-1	$\mu A$
Gate-Body leakage current	$I_{GS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 10$	$\mu A$
Gate to Source Cutoff Voltage	$V_{GS(off)}$	$V_{GS} = -5V, I_D = -1mA$	-1.4		-2.4	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = -10V, I_D = -10mA$			20	$\Omega$
		$V_{GS} = -4V, I_D = -10mA$			30	
		$V_{GS} = -5V, I_D = -10mA$				
Forward Transconductance	$g_{FS}$	$V_{DS} = -5V, I_D = -10mA$	20	45		$mS$
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = -5V, f = 1MHz$		27		$pF$
Output Capacitance	$C_{oss}$			16		
Reverse Transfer Capacitance	$C_{rss}$			2		
Turn-On DelayTime	$t_{d(on)}$	$V_{GS(on)} = -4V, I_D = -10mA, R_L = 500 \Omega, R_G = 10 \Omega, V_{DD} = -5V$		110		ns
Turn-On Rise Time	$t_r$			150		
Turn-Off DelayTime	$t_{d(off)}$			160		
Turn-Off Fall Time	$t_f$			150		

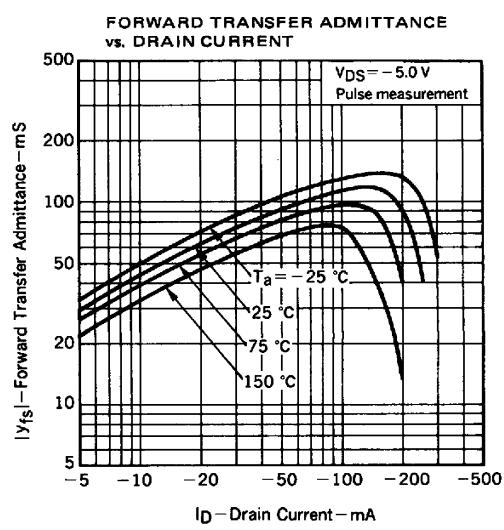
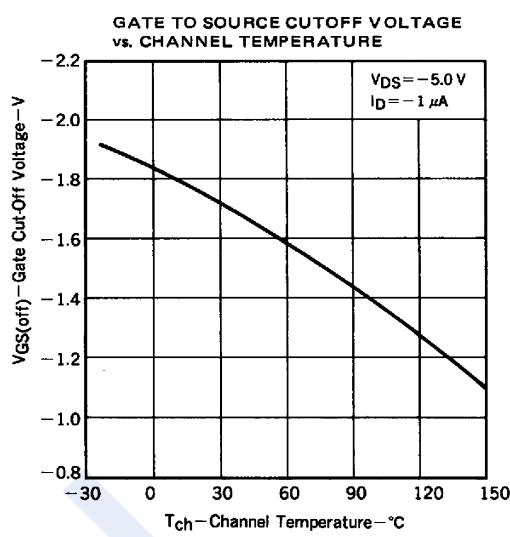
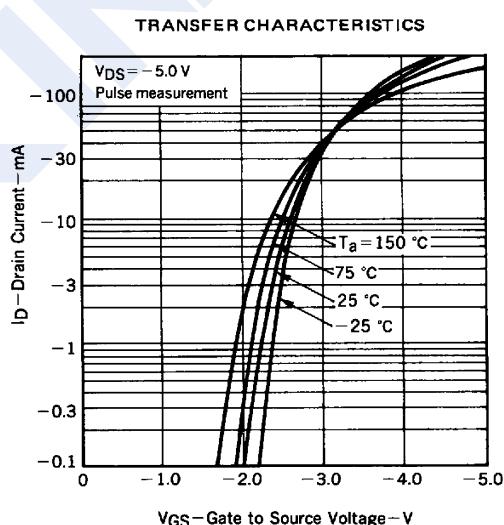
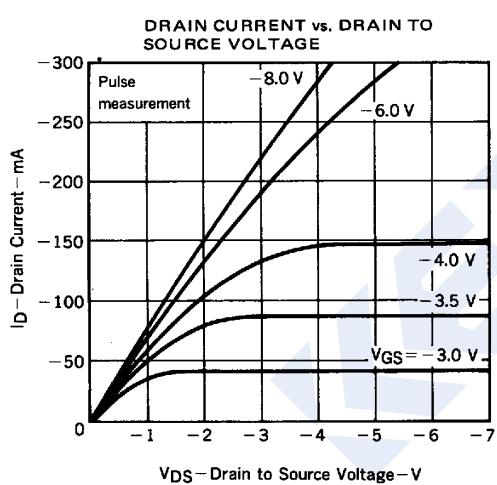
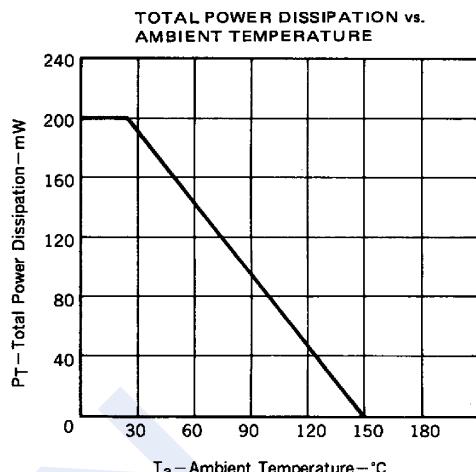
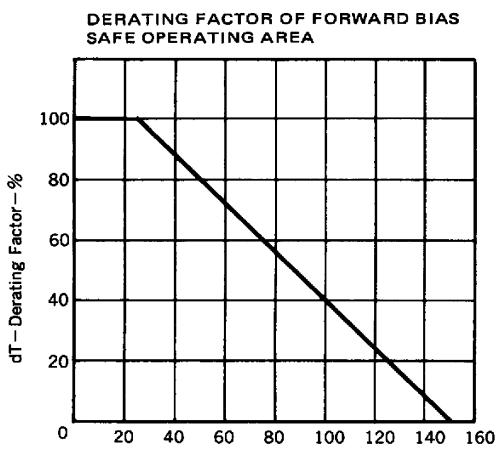
## ■ Marking

Marking	H18
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## P-Channel MOSFET

## 2SJ211

## ■ Typical Characteristics



## P-Channel MOSFET

2SJ211

## ■ Typical Characteristics

